



# **Chopper Stabilized Precision Hall Effect Latches**

# **Features and Benefits**

- Symmetrical latch switchpoints
- Resistant to physical stress
- Superior temperature stability
- Output short-circuit protection
- Operation from unregulated supply down to 3 V
- Reverse battery protection
- Solid-state reliability
- Small package sizes

# Packages:



Not to scale

### Description

The A1220, A1221, and A1222 Hall-effect sensor ICs are extremely temperature-stable and stress-resistant devices especially suited for operation over extended temperature ranges to 150°C. Superior high-temperature performance is made possible through dynamic offset cancellation, which reduces the residual offset voltage normally caused by device overmolding, temperature dependencies, and thermal stress. Each device includes on a single silicon chip a voltage regulator, Hall-voltage generator, small-signal amplifier, chopper stabilization, Schmitt trigger, and a short-circuit protected open-collector output to sink up to 25 mA. A south pole of sufficient strength turns the output on. A north pole of sufficient strength is necessary to turn the output off.

An onboard regulator permits operation with supply voltages of 3 to 24 V. The advantage of operating down to 3 V is that the device can be used in 3-V applications or with additional external resistance in series with the supply pin for greater protection against high voltage transient events.

Two package styles provide magnetically optimized packages for most applications. Package type LH is a modified 3-pin SOT23W surface mount package while UA is a three-pin ultramini SIP for through hole mounting. Both packages are lead (Pb) free, with 100% matter tin plated leadframes.

# Punctional Block Diagram



# A1220, A1221 and A1222 UA-T"供应管hopper Stabilized Precision Hall Effect Latches

#### **Selection Guide**

Part Number	Packing <sup>1</sup>	Mounting	Ambient, T <sub>A</sub>	B <sub>RP</sub> (Min)	B <sub>OP</sub> (Max)
A1220ELHLX-T	13-in. reel, 10000 pieces/reel	3-pin SOT23W surface mount			
A1220ELHLT-T <sup>2</sup>	7-in. reel, 3000 pieces/reel	3-pin SOT23W surface mount	-40°C to 85°C		
A1220EUA-T	Bulk, 500 pieces/bag	3-pin SIP through hole		-40	40
A1220LLHLX-T	13-in. reel, 10000 pieces/reel	3-pin SOT23W surface mount		-40	40
A1220LLHLT-T <sup>2</sup>	7-in. reel, 3000 pieces/reel	3-pin SOT23W surface mount	-40°C to 150°C		
A1220LUA-T	Bulk, 500 pieces/bag	3-pin SIP through hole			
A1221ELHLX-T	13-in. reel, 10000 pieces/reel	3-pin SOT23W surface mount			
A1221ELHLT-T <sup>2</sup>	7-in. reel, 3000 pieces/reel	3-pin SOT23W surface mount			
A1221EUA-T	Bulk, 500 pieces/bag	3-pin SIP through hole			00
A1221LLHLX-T	13-in. reel, 10000 pieces/reel	3-pin SOT23W surface mount		-90	90
A1221LLHLT-T <sup>2</sup>	7-in. reel, 3000 pieces/reel	3-pin SOT23W surface mount	-40°C to 150°C		
A1221LUA-T	Bulk, 500 pieces/bag	3-pin SIP through hole			
A1222ELHLT-T	7-in. reel, 3000 pieces/reel	3-pin SOT23W surface mount	1000 to 0500		
A1222ELHLX-T <sup>2</sup>	13-in. reel, 10000 pieces/reel	3-pin SOT23W surface mount	-40°C to 85°C		
A1222LLHLT-T	7-in. reel, 3000 pieces/reel	3-pin SOT23W surface mount		-150	
A1222LLHLX-T <sup>2</sup>	13-in. reel, 10000 pieces/reel	3-pin SOT23W surface mount	-40°C to 150°C		
A1222LUA-T	Bulk, 500 pieces/bag	3-pin SIP through hole			

<sup>1</sup>Contact Allegro for additional packing options.

<sup>2</sup>Available through authorized Allegro distributors only.

#### **Absolute Maximum Ratings**

Characteristic	Symbol	Notes	Rating	Units				
Forward Supply Voltage	V <sub>CC</sub>		26.5	V				
Reverse Supply Voltage	V <sub>RCC</sub>		-30	V				
Output Off Voltage	V <sub>OUT</sub>		26	V				
Continuous Output Current	I <sub>OUT</sub>		25	mA				
Reverse Output Current	I <sub>ROUT</sub>		-50	mA				
Operating Ambient Temperature	т	Range F	-40 to 85	°C				
Operating Ambient Temperature	T <sub>A</sub>	Range L	-40 to 150	°C				
Maximum Junction Temperature	T <sub>J</sub> (max)		165	°C				
Storage Temperature	T <sub>stg</sub>		-65 to 170	°C				

Package LH

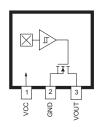


/UIT

VCC

# **Pin-out Diagrams**

Package UA



Terminal List	>		-
Name	Description	Number	nber
Name	Description	Package LH	Package UA
VCC	Connects power supply to chip	1	1
VOUT	Output from circuit	2	3
GND	Ground	3	2



Allegro MicroSystems, Inc. 115 Northeast Cutoff Worcester, Massachusetts 01615-0036 U.S.A. 1.508.853.5000; www.allegromicro.com



#### A1220, A1221 and A1222 LUA-T"供应 hopper Stabilized Precision Hall Effect Latches

### ELECTRICAL CHARACTERISTICS Valid valid over full operating voltage and ambient temperature ranges; unless otherwise noted

Characteristics	Symbol	Test Conditions	Min.	Typ. <sup>1</sup>	Max.	Unit <sup>2</sup>
Electrical Characteristics	1	1	I			
Forward Supply Voltage	V <sub>CC</sub>	Operating, T <sub>J</sub> < 165°C	3	-	24	V
Output Leakage Current	IOUTOFF	V <sub>OUT</sub> = 24 V, B < B <sub>RP</sub>	-	-	10	μA
Output Saturation Voltage	V <sub>OUT(SAT)</sub>	I <sub>OUT</sub> = 20 mA, B > B <sub>OP</sub>	-	185	500	mV
Output Current Limit	I <sub>OM</sub>	B > B <sub>OP</sub>	30	-	60	mA
Power-On Time <sup>3</sup>	t <sub>PO</sub>	V <sub>CC</sub> > 3.0 V, B < B <sub>RP</sub> (min) – 10 G, B > B <sub>OP</sub> (max) + 10 G	-	-	25	μs
Chopping Frequency	f <sub>C</sub>		-	800	_	kHz
Output Rise Time <sup>3,4</sup>	tr	R <sub>L</sub> = 820 Ω, C <sub>L</sub> = 20 pF	-	0.2	2	μs
Output Fall Time <sup>3,4</sup>	t <sub>f</sub>	R <sub>L</sub> = 820 Ω, C <sub>L</sub> = 20 pF	-	0.1	2	μs
	I <sub>CC(ON)</sub>	B > B <sub>OP</sub> , V <sub>CC</sub> = 12 V	-	-	4	mA
Supply Current	I <sub>CC(OFF)</sub>	B < B <sub>RP</sub> , V <sub>CC</sub> = 12 V	-	-	4	4 mA
Reverse Supply Current	I <sub>RCC</sub>	V <sub>RCC</sub> = -30 V	-	-	-5	mA
Supply Zener Clamp Voltage	Vz	$I_{CC} = 5 \text{ mA}; T_A = 25^{\circ}\text{C}$	28	-	-	V
Zener Impedance	Ι <sub>Z</sub>	$I_{CC} = 5 \text{ mA}; T_{A} = 25^{\circ}\text{C}$	-	50	-	Ω
Magnetic Characteristics						
		A1220	5	22	40	G
Operate Point	B <sub>OP</sub>	A1221	15	4 r 5 r 28 - 50 5 22 40 15 50 90 70 110 150	G	
		A1222	70	110	150	G
		A1220	-40	-23	-5	G
Release Point	B <sub>RP</sub>	A1221	-90	-50	-15	G
		A1222	-150	-110	-70	_
		A1220 (B B )	10	45	80	G
Hysteresis	B <sub>HYS</sub>	(B <sub>OP</sub> – B <sub>RP</sub> )	30	100	180	G
		A1222	140	220	300	G

<sup>1</sup>Typical data are are at  $T_A$  = 25°C and  $V_{CC}$  = 12 V, and are for initial design estimations only.

 $^{21}$  G (gauss) = 0.1 mT (millitesla).

<sup>3</sup>Guaranteed by device design and characterization.

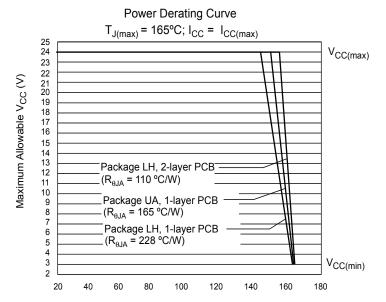
 ${}^{4}C_{L}$  = oscilloscope probe capacitance.



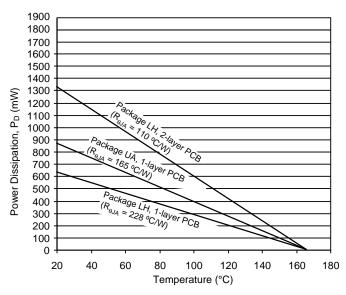
#### A1220, A1221 and A1222 A1222 A1222

#### THERMAL CHARACTERISTICS may require derating at maximum conditions, see application information

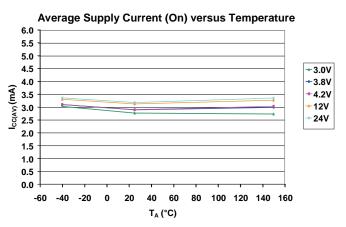
Characteristic	Symbol	Test Conditions		Units
		Package LH, 1-layer PCB with copper limited to solder pads	228	°C/W
Package Thermal Resistance	AI RESISTANCE R <sub>0JA</sub>	Package LH, 2-layer PCB with 0.463 in. <sup>2</sup> of copper area each side connected by thermal vias		°C/W
		Package UA, 1-layer PCB with copper limited to solder pads	165	°C/W



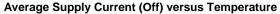
#### Power Dissipation versus Ambient Temperature

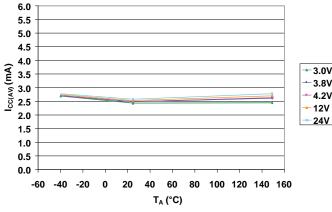


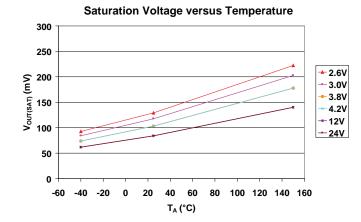




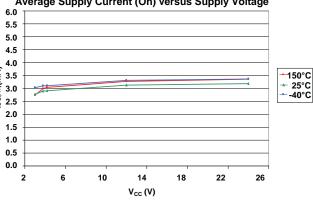
**Characteristic Performance** A1220, A1221, and A1222 Electrical Characteristics



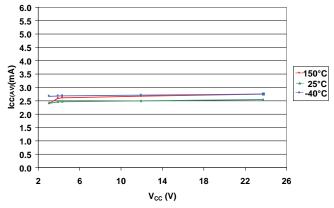


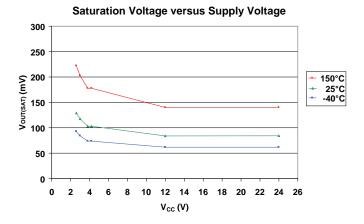


Average Supply Current (On) versus Supply Voltage 6.0 5.5 5.0 4.5 4.0 4.0 3.5 3.0 2.5 2.5 150°C + 25°C - -40°C 3.0 2.0 1.5 1.0 0.5 0.0 2 6 10 14 18 22 26 V<sub>cc</sub> (V)



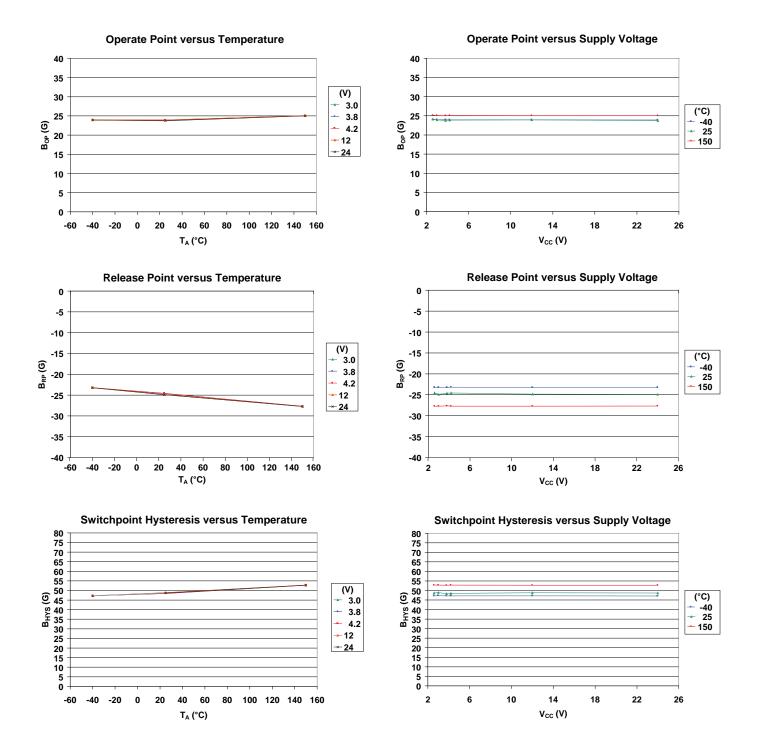
Average Supply Current (Off) versus Supply Voltage





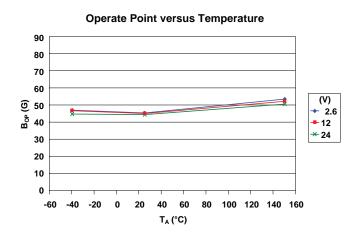


# A1220 Magnetic Characteristics

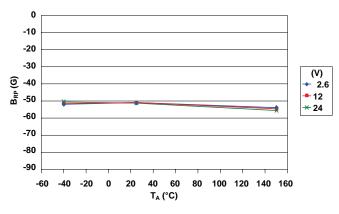


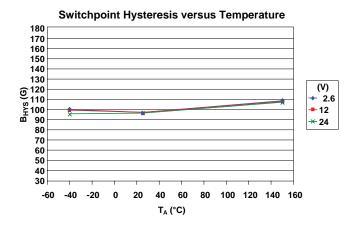


# A1221 Magnetic Characteristics

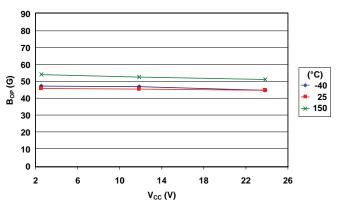


**Release Point versus Temperature** 

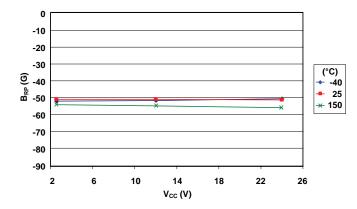


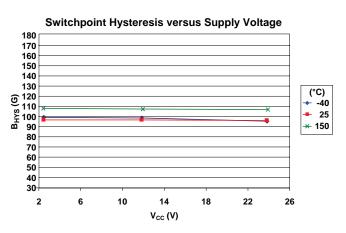


Operate Point versus Supply Voltage



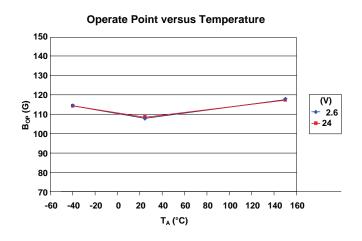
**Release Point versus Supply Voltage** 



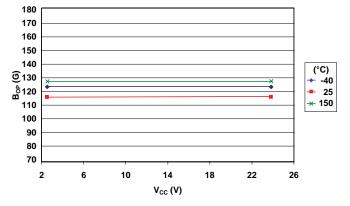




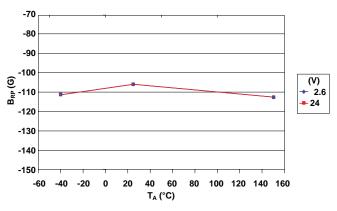
# A1222 Magnetic Characteristics

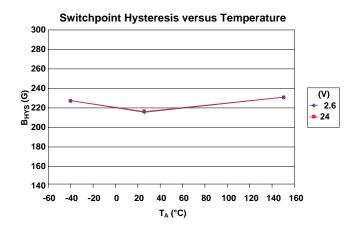


Operate Point versus Supply Voltage

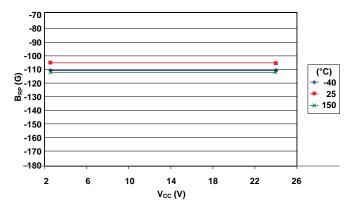


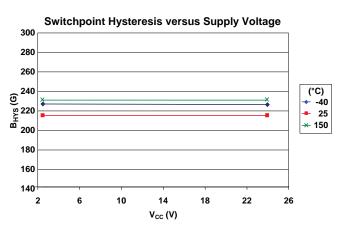
**Release Point versus Temperature** 





**Release Point versus Supply Voltage** 







# A1220, A1221 and A1222LUA-T"供应管hopper Stabilized Precision Hall Effect Latches

# **Functional Description**

#### Operation

The output of these devices switches low (turns on) when a magnetic field perpendicular to the Hall element exceeds the operate point threshold,  $B_{OP}$  (see panel A of figure 1). After turn-on, the output voltage is  $V_{OUT(SAT)}$ . The output transistor is capable of sinking current up to the short circuit current limit,  $I_{OM}$ , which is a minimum of 30 mA. When the magnetic field is reduced below the release point,  $B_{RP}$ , the device output goes high (turns off). The difference in the magnetic operate and release points is the hysteresis,  $B_{HYS}$ , of the device. This built-in hysteresis allows clean switching of the output even in the presence of external mechanical vibration and electrical noise.

Removal of the magnetic field will leave the device output latched on if the last crossed switchpoint is  $B_{OP}$ , or latched off if the last crossed switch point is  $B_{RP}$ .

Powering-on the device in the hysteresis range (less than  $B_{OP}$  and higher than  $B_{RP}$ ) will give an indeterminate output state. The correct state is attained after the first excursion beyond  $B_{OP}$  or  $B_{RP}$ .

#### Applications

It is strongly recommended that an external bypass capacitor be connected (in close proximity to the Hall element) between the supply and ground of the device to reduce both external noise and noise generated by the chopper stabilization technique. As is shown in panel B of figure 1, a 0.1  $\mu$ F capacitor is typical.

Extensive applications information for Hall effect devices is available in:

- Hall-Effect IC Applications Guide, Application Note 27701
- *Guidelines for Designing Subassemblies Using Hall-Effect Devices*, Application Note 27703.1
- Soldering Methods for Allegro's Products SMT and Through-Hole, Application Note 26009

All are provided in *Allegro Electronic Data Book*, AMS-702, and the Allegro Web site, www.allegromicro.com.

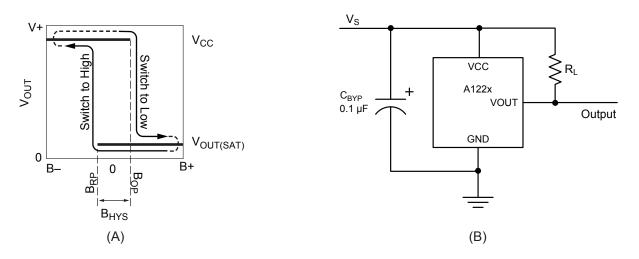


Figure 1. Switching behavior of latches. In panel A, on the horizontal axis, the B+ direction indicates increasing south polarity magnetic field strength, and the B– direction indicates decreasing south polarity field strength (including the case of increasing north polarity). This behavior can be exhibited when using a circuit such as that shown in panel B.



# A1220, A1221 and A1222LUA-T"供应管hopper Stabilized Precision Hall Effect Latches

#### **Chopper Stabilization Technique**

When using Hall effect technology, a limiting factor for switchpoint accuracy is the small signal voltage developed across the Hall element. This voltage is disproportionally small relative to the offset that can be produced at the output of the Hall element. This makes it difficult to process the signal while maintaining an accurate, reliable output over the specified operating temperature and voltage ranges.

Chopper stabilization is a unique approach used to minimize Hall offset on the chip. The patented Allegro technique, namely Dynamic Quadrature Offset Cancellation, removes key sources of the output drift induced by thermal and mechanical stresses. This offset reduction technique is based on a signal modulationdemodulation process. The undesired offset signal is separated from the magnetic field-induced signal in the frequency domain, through modulation. The subsequent demodulation acts as a modulation process for the offset, causing the magnetic field induced signal to recover its original spectrum at baseband, while the dc offset becomes a high-frequency signal. The magnetic sourced signal then can pass through a low-pass filter, while the modulated DC offset is suppressed. This configuration is illustrated in figure 2. The chopper stabilization technique uses a 400 kHz high frequency clock. For demodulation process, a sample and hold technique is used, where the sampling is performed at twice the chopper frequency (800 kHz). This high-frequency operation allows a greater sampling rate, which results in higher accuracy and faster signal-processing capability. This approach desensitizes the chip to the effects of thermal and mechanical stresses, and produces devices that have extremely stable quiescent Hall output voltages and precise recoverability after temperature cycling. This technique is made possible through the use of a BiCMOS process, which allows the use of low-offset, low-noise amplifiers in combination with high-density logic integration and sample-and-hold circuits.

The repeatability of magnetic field-induced switching is affected slightly by a chopper technique. However, the Allegro high frequency chopping approach minimizes the affect of jitter and makes it imperceptible in most applications. Applications that are more likely to be sensitive to such degradation are those requiring precise sensing of alternating magnetic fields; for example, speed sensing of ring-magnet targets. For such applications, Allegro recommends its digital device families with lower sensitivity to jitter. For more information on those devices, contact your Allegro sales representative.

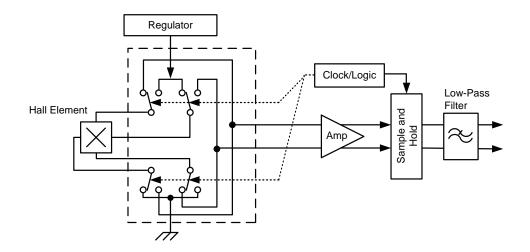


Figure 2. Model of chopper stabilization technique



# A1220, A1221 and A1222LUA-T"供应管hopper Stabilized Precision Hall Effect Latches

#### **Power Derating**

The device must be operated below the maximum junction temperature of the device,  $T_{J(max)}$ . Under certain combinations of peak conditions, reliable operation may require derating supplied power or improving the heat dissipation properties of the application. This section presents a procedure for correlating factors affecting operating  $T_J$ . (Thermal data is also available on the Allegro MicroSystems website.)

The Package Thermal Resistance,  $R_{\theta JA}$ , is a figure of merit summarizing the ability of the application and the device to dissipate heat from the junction (die), through all paths to the ambient air. Its primary component is the Effective Thermal Conductivity, K, of the printed circuit board, including adjacent devices and traces. Radiation from the die through the device case,  $R_{\theta JC}$ , is relatively small component of  $R_{\theta JA}$ . Ambient air temperature,  $T_A$ , and air motion are significant external factors, damped by overmolding.

The effect of varying power levels (Power Dissipation,  $P_D$ ), can be estimated. The following formulas represent the fundamental relationships used to estimate  $T_J$ , at  $P_D$ .

$$P_{D} = V_{IN} \times I_{IN}$$
(1)  
$$\Delta T = P_{D} \times R_{\theta JA}$$
(2)  
$$T_{I} = T_{A} + \Delta T$$
(3)

For example, given common conditions such as:  $T_A = 25$  °C,  $V_{CC} = 12$  V,  $I_{CC} = 1.6$  mA, and  $R_{\theta JA} = 165$  °C/W, then:

$$P_D = V_{CC} \times I_{CC} = 12 \text{ V} \times 1.6 \text{ mA} = 19 \text{ mW}$$
$$\Delta T = P_D \times R_{\theta JA} = 19 \text{ mW} \times 165 \text{ °C/W} = 3 \text{ °C}$$
$$T_J = T_A + \Delta T = 25 \text{ °C} + 3 \text{ °C} = 28 \text{ °C}$$

A worst-case estimate,  $P_{D(max)}$ , represents the maximum allowable power level ( $V_{CC(max)}$ ,  $I_{CC(max)}$ ), without exceeding  $T_{J(max)}$ , at a selected  $R_{\theta JA}$  and  $T_A$ .

*Example*: Reliability for  $V_{CC}$  at  $T_A$ =150°C, package LH, using a minimum-K PCB.

Observe the worst-case ratings for the device, specifically:  $R_{\theta JA}=228$ °C/W,  $T_J(max)=165$ °C,  $V_{CC}(max)=24$  V, and  $I_{CC}(max)=4$  mA.

Calculate the maximum allowable power level,  $P_D(max)$ . First, invert equation 3:

$$\Delta T_{max} = T_J(max) - T_A = 165 \,^{\circ}\text{C} - 150 \,^{\circ}\text{C} = 15 \,^{\circ}\text{C}$$

This provides the allowable increase to  $T_J$  resulting from internal power dissipation. Then, invert equation 2:

$$P_D(max) = \Delta T_{max} \div R_{\theta JA} = 15^{\circ}C \div 228 \circ C/W = 66 \text{ mW}$$

Finally, invert equation 1 with respect to voltage:

 $V_{CC(est)} = P_D(max) \div I_{CC}(max) = 66 \text{ mW} \div 4 \text{ mA} = 16.4 \text{ V}$ 

The result indicates that, at  $T_A$ , the application and device can dissipate adequate amounts of heat at voltages  $\leq V_{CC(est)}$ .

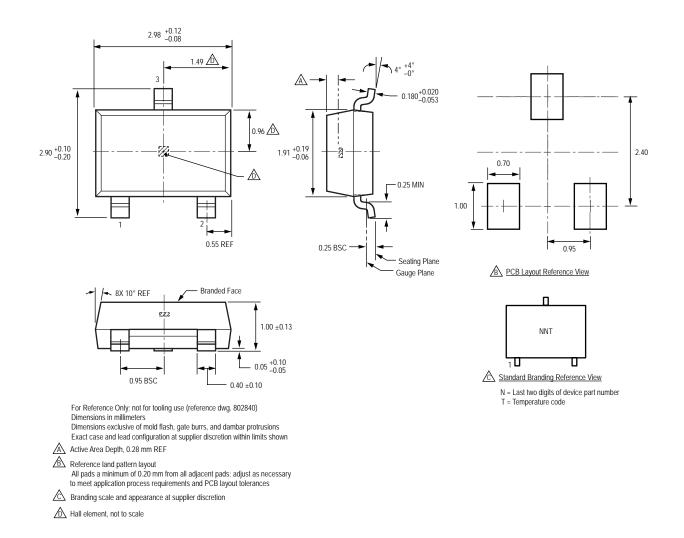
Compare  $V_{CC(est)}$  to  $V_{CC}(max)$ . If  $V_{CC(est)} \leq V_{CC}(max)$ , then reliable operation between  $V_{CC(est)}$  and  $V_{CC}(max)$  requires enhanced  $R_{\theta JA}$ . If  $V_{CC(est)} \geq V_{CC}(max)$ , then operation between  $V_{CC(est)}$  and  $V_{CC}(max)$  is reliable under these conditions.



11

# A1220, A1221 and A1222 UA-T"供应 hopper Stabilized Precision Hall Effect Latches

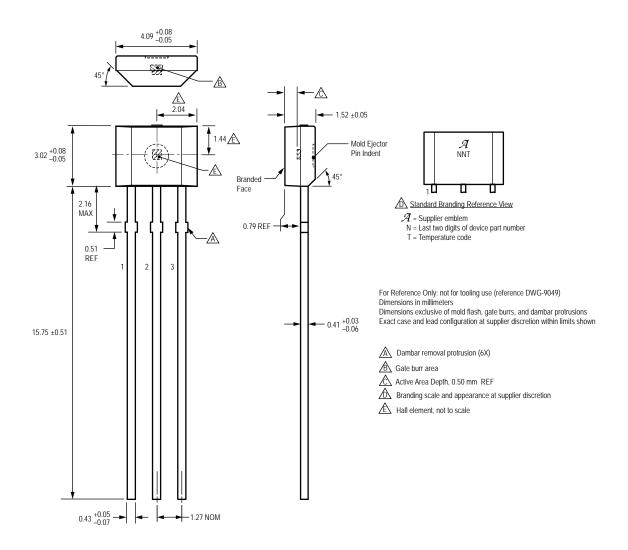
# Package LH, 3-Pin (SOT-23W)





# A1220, A1221 and A1222 UA-T"供应管hopper Stabilized Precision Hall Effect Latches

Package UA, 3-Pin SIP



Copyright ©2009, Allegro MicroSystems, Inc.

The products described herein are manufactured under one or more of the following U.S. patents: 5,517,112; 5,619,137; 5,621,319; 7,425,821 and/ or other patents pending.

Allegro MicroSystems, Inc. reserves the right to make, from time to time, such departures from the detail specifications as may be required to permit improvements in the performance, reliability, or manufacturability of its products. Before placing an order, the user is cautioned to verify that the information being relied upon is current.

<u>Allegro's products are not to be used in life support devices or systems, if a failure of an Allegro product can reasonably be expected to cause the failure of that life support device or system, or to affect the safety or effectiveness of that device or system.</u>

The information included herein is believed to be accurate and reliable. However, Allegro MicroSystems, Inc. assumes no responsibility for its use; nor for any infringement of patents or other rights of third parties which may result from its use.

For the latest version of this document, visit our website: www.allegromicro.com

